

ONYX® 2" IC Target, Standard Magnetics

US Specifications

Со	nstruction	·			
	Anode		304 Stainless Stee	I	
	Cathode Body		OFHC Copper		
	Insulator		CTFE		
Cooling Requirements					
	Flow Rate at Maximum Power Maximum Input Pressure, Open Drain		0.75 GPM		
			60 psi		
	Maximum Input	Temperature	68 °F		
Dir	mensions				
	A	2.813"	H	——B——→I	
	В	2.440"			
	С	0.750"	ţ (
			⊺ ↓)		

General

Magnetic Enhancement	Permanent (NdFeB) Encapsulated	
Maximum Temperature	212 °F	
Source to Substrate Distance	2.000" - 12.000"	
Weight, Approximate Without Options	3 lb	

Maximum Sputtering Power *

Cathode Voltage	100 - 1500 Volts
Discharge Current	0.1 - 2 Amps
Indirect Cooled Mode, DC	1 kW
Indirect Cooled Mode, RF	600 Watts
Operating Pressure	0.5 - 50 mTorr

Mounting, Standard

Power Cable, DC	1675A	
Power Cable, RF	1675A	
Power Connector, DC	Type N Connector, External Threads	
Power Connector, RF	Type HN Connector, External Threads	
Stem, Outer Dimension Tubing	0.750"	
Water, Outer Dimension Tubing	0.250"	

Target

Cooling	Indirect
Diameter	2.000"
Form	Circular / Planar
Thickness	0.010" - 0.375"

Specifications Disclaimer

- All Angstrom Sciences NdFeB magnets are totally encapsulated and protected from degradation by water.
- All sources are available in external configurations.
- * Maximum power for cathode only, a target material's properties, such as, thermal and electrical conductivity may limit the maximum process power level.
- Some custom-engineered and specialty magnetrons may not meet standard specifications.
- Specifications are subject to change without notice.
- Typical performance. Results may vary with process parameters such as pressure, flow rate, target material, and substrate rotation, etc.

Please contact us for specifications regarding your application.

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